

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**High frequency inductive components – Non-electrical characteristics and measuring methods –
Part 2: Test methods for non-electrical characteristics**

**Composants inductifs à haute fréquence – Caractéristiques non électriques et méthodes de mesure –
Partie 2: Méthodes d'essai pour caractéristiques non électriques**





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INTERNATIONAL ELECTROTECHNICAL COMMISSION

HIGH FREQUENCY INDUCTIVE COMPONENTS – NON-ELECTRICAL CHARACTERISTICS AND MEASURING METHODS –

Part 2: Test methods for non-electrical characteristics

FOREWORD

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International Standard IEC 62025-2 has been prepared by IEC technical committee 51: Magnetic components, ferrite and magnetic powder materials.

This second edition cancels and replaces the first edition published in 2005. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) revision of Table 5;
- b) revision of normative references.

The text of this standard is based on the following documents:

CDV	Report on voting
51/1273/CDV	51/1301/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62025 series, published under the general title *High frequency inductive components – Non-electrical characteristics and measuring methods*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

HIGH FREQUENCY INDUCTIVE COMPONENTS – NON-ELECTRICAL CHARACTERISTICS AND MEASURING METHODS –

Part 2: Test methods for non-electrical characteristics

1 Scope

This part of IEC 62025 specifies a test method for the non-electrical characteristics of the surface mounted device (SMD) inductors to be used for electronic and telecommunication equipment. The object of this part of this document is to define methods for measuring mechanical performance only. As the reliability performances and specifications relative to non-electrical performances are defined in IEC 62211, detailed measuring methods for mechanical performance of reliability testing are defined in this document.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-1, *Environmental testing – Part 1: General and guidance*

IEC 60068-2-6:2007, *Environmental testing – Part 2: Tests – Test Fc: Vibration (sinusoidal)*

IEC 60068-2-20, *Environmental testing – Part 2-20: Tests – Test T: Test methods for solderability and resistance to soldering heat of devices with leads*

IEC 60068-2-21:2006, *Environmental testing – Part 2-21: Tests – Test U: Robustness of terminations and integral mounting devices*

IEC 60068-2-27, *Environmental testing – Part 2-27: Tests – Test Ea and guidance: Shock*

IEC 60068-2-45:1980, *Basic environmental testing procedures – Part 2-45: Tests – Test XA and guidance: Immersion in cleaning solvents*

IEC 60068-2-45:1980/AMD1:1993

IEC 60068-2-58:2015, *Environmental testing – Part 2-58: Tests – Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)*

IEC 60068-2-58:2015/AMD1:2017

IEC 60068-2-69, *Environmental testing – Part 2-69: Tests – Test Te/Tc: Solderability testing of electronic components and printed boards by the wetting balance (force measurement) method*

IEC 60068-2-77, *Environmental testing – Part 2-77: Tests – Test 77: Body strength and impact shock*

IEC 61188-5-2, *Printed boards and printed board assemblies – Design and use – Part 5-2: Attachment (land/joint) considerations – Discrete components*